

# XPT IGBT

tentative

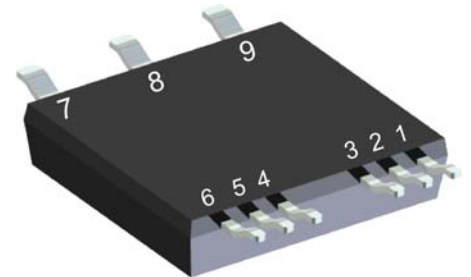
$$V_{CES} = 1200V$$

$$I_{C25} = 61A$$

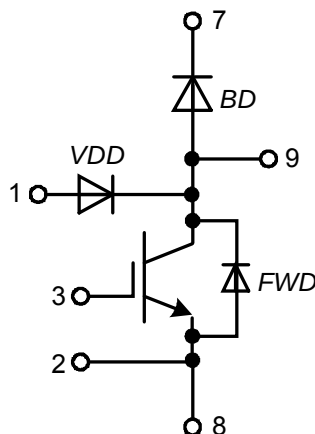
$$V_{CE(sat)} = 1.8V$$

ISOPLUS™ Surface Mount Power Device  
Boost Topology  
XPT IGBT

Part number

**IXA40RG1200DHGLB**


Backside: isolated

## Features / Advantages:

- XPT IGBT
  - low saturation voltage
  - positive temperature coefficient for easy paralleling
  - fast switching
  - short tail current for optimized performance in resonant circuits
- Sonic™ diode
  - fast reverse recovery
  - low operating forward voltage
  - low leakage current
  - low temperature dependency of reverse recovery
- Vcesat detection diode (VDD)
  - integrated into package
  - very fast diode

## Applications:

- AC drives
  - brake chopper
- PFC
  - boost chopper
- Switched reluctance drives

## Package: SMPD

- Industry convenient outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Soldering pins for PCB mounting
- Backside: DCB ceramic
- Reduced weight
- Advanced power cycling
- Isolation Voltage: 3000 V~

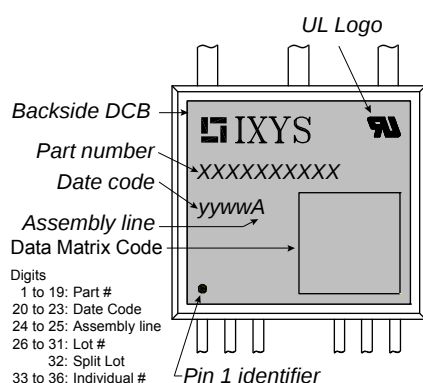
| Free Wheeling Diode FWD |                                              |                                                |                         | Ratings                 |      |      |      |
|-------------------------|----------------------------------------------|------------------------------------------------|-------------------------|-------------------------|------|------|------|
| Symbol                  | Definition                                   | Conditions                                     |                         | min.                    | typ. | max. | Unit |
| V <sub>RSM</sub>        | max. non-repetitive reverse blocking voltage | T <sub>VJ</sub> = 25°C                         |                         |                         |      | 1200 | V    |
| V <sub>RRM</sub>        | max. repetitive reverse blocking voltage     | T <sub>VJ</sub> = 25°C                         |                         |                         |      | 1200 | V    |
| I <sub>R</sub>          | reverse current, drain current               | V <sub>R</sub> = 1200 V                        | T <sub>VJ</sub> = 25°C  |                         |      | 30   | μA   |
|                         |                                              | V <sub>R</sub> = 1200 V                        | T <sub>VJ</sub> = 125°C |                         |      | 0.5  | mA   |
| V <sub>F</sub>          | forward voltage drop                         | I <sub>F</sub> = 30 A                          | T <sub>VJ</sub> = 25°C  |                         |      | 2.20 | V    |
|                         |                                              | I <sub>F</sub> = 60 A                          |                         |                         |      |      | V    |
|                         |                                              | I <sub>F</sub> = 30 A                          | T <sub>VJ</sub> = 125°C |                         |      | 2.20 | V    |
|                         |                                              | I <sub>F</sub> = 60 A                          |                         |                         |      |      | V    |
| I <sub>FAV</sub>        | average forward current                      | T <sub>C</sub> = 80°C                          | T <sub>VJ</sub> = 150°C |                         |      | 25   | A    |
|                         |                                              | rectangular      d = 0.5                       |                         |                         |      |      |      |
| V <sub>F0</sub>         | threshold voltage                            | } for power loss calculation only              |                         | T <sub>VJ</sub> = 150°C |      | 1.26 | V    |
| r <sub>F</sub>          | slope resistance                             |                                                |                         |                         |      | 28   | mΩ   |
| R <sub>thJC</sub>       | thermal resistance junction to case          |                                                |                         |                         |      | 1    | K/W  |
| R <sub>thCH</sub>       | thermal resistance case to heatsink          |                                                |                         |                         | 0.30 |      | K/W  |
| P <sub>tot</sub>        | total power dissipation                      |                                                | T <sub>C</sub> = 25°C   |                         |      | 125  | W    |
| I <sub>FSM</sub>        | max. forward surge current                   | t = 10 ms; (50 Hz), sine; V <sub>R</sub> = 0 V | T <sub>VJ</sub> = 45°C  |                         |      | 200  | A    |
| C <sub>J</sub>          | junction capacitance                         | V <sub>R</sub> = 400 V    f = 1 MHz            | T <sub>VJ</sub> = 25°C  |                         | 13   |      | pF   |

| VCEsat Detection Diode VDD |                                          |                                                                     |                         | Ratings                 |      |      |      |
|----------------------------|------------------------------------------|---------------------------------------------------------------------|-------------------------|-------------------------|------|------|------|
| Symbol                     | Definition                               | Conditions                                                          |                         | min.                    | typ. | max. | Unit |
| V <sub>RRM</sub>           | max. repetitive reverse blocking voltage | T <sub>VJ</sub> = 25°C                                              |                         |                         |      | 1200 | V    |
| I <sub>R</sub>             | reverse current, drain current           | V <sub>R/D</sub> = 1200 V                                           | T <sub>VJ</sub> = 25°C  |                         |      | 2    | μA   |
|                            |                                          | V <sub>R/D</sub> = 1200 V                                           | T <sub>VJ</sub> = 125°C |                         |      | 0.03 | mA   |
| V <sub>F</sub>             | forward voltage drop                     | I <sub>F</sub> = 1 A                                                | T <sub>VJ</sub> = 25°C  |                         |      | 2.20 | V    |
|                            |                                          | I <sub>F</sub> = 1 A                                                | T <sub>VJ</sub> = 125°C |                         |      | 1.80 | V    |
| V <sub>F0</sub>            | threshold voltage                        | } for power loss calculation only                                   |                         |                         |      | 1.30 | V    |
| r <sub>F</sub>             | slope resistance                         |                                                                     |                         |                         |      | 390  | mΩ   |
| C <sub>J</sub>             | junction capacitance                     | V <sub>R</sub> = 400 V; f = 1 MHz                                   |                         | T <sub>VJ</sub> = 25°C  |      | tbd  | pF   |
| I <sub>RM</sub>            | max. reverse recovery current            | } V <sub>R</sub> = 100 V; I <sub>F</sub> = 1 A<br>-di/dt = 100 A/μs |                         | T <sub>VJ</sub> = 25°C  |      | 2.3  | A    |
| t <sub>rr</sub>            | reverse recovery time                    |                                                                     |                         | T <sub>VJ</sub> = 125°C |      | tbd  | A    |
|                            |                                          |                                                                     |                         | T <sub>VJ</sub> = 25°C  |      | 40   | ns   |
|                            |                                          |                                                                     |                         | T <sub>VJ</sub> = 125°C |      | tbd  | ns   |

| Boost IGBT            |                                       |                                                                                                                                                                                        |                                | Ratings |      |          |               |
|-----------------------|---------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------|---------|------|----------|---------------|
| Symbol                | Definition                            | Conditions                                                                                                                                                                             |                                | min.    | typ. | max.     | Unit          |
| $V_{CES}$             | collector emitter voltage             | $T_{VJ} = 25^{\circ}\text{C}$                                                                                                                                                          |                                |         |      | 1200     | V             |
| $V_{GES}$             | max. DC gate voltage                  |                                                                                                                                                                                        |                                |         |      | $\pm 20$ | V             |
| $V_{GEM}$             | max. transient collector gate voltage |                                                                                                                                                                                        |                                |         |      | $\pm 30$ | V             |
| $I_{C25}$             | collector current                     | $T_C = 25^{\circ}\text{C}$                                                                                                                                                             |                                |         |      | 61       | A             |
| $I_{C80}$             |                                       | $T_C = 80^{\circ}\text{C}$                                                                                                                                                             |                                |         |      | 43       | A             |
| $P_{tot}$             | total power dissipation               | $T_C = 25^{\circ}\text{C}$                                                                                                                                                             |                                |         |      | 215      | W             |
| $V_{CE(sat)}$         | collector emitter saturation voltage  | $I_C = 35\text{ A}; V_{GE} = 15\text{ V}$                                                                                                                                              | $T_{VJ} = 25^{\circ}\text{C}$  |         | 1.8  | 2.1      | V             |
|                       |                                       |                                                                                                                                                                                        | $T_{VJ} = 125^{\circ}\text{C}$ |         | 2.1  |          | V             |
| $V_{GE(th)}$          | gate emitter threshold voltage        | $I_C = 1.5\text{ mA}; V_{GE} = V_{CE}$                                                                                                                                                 | $T_{VJ} = 25^{\circ}\text{C}$  | 5.4     | 5.9  | 6.5      | V             |
| $I_{CES}$             | collector emitter leakage current     | $V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$                                                                                                                                                | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 0.1      | mA            |
|                       |                                       |                                                                                                                                                                                        | $T_{VJ} = 125^{\circ}\text{C}$ |         | 0.1  |          | mA            |
| $I_{GES}$             | gate emitter leakage current          | $V_{GE} = \pm 20\text{ V}$                                                                                                                                                             |                                |         |      | 500      | nA            |
| $Q_{G(on)}$           | total gate charge                     | $V_{CE} = 600\text{ V}; V_{GE} = 15\text{ V}; I_C = 35\text{ A}$                                                                                                                       |                                |         | 107  |          | nC            |
| $t_{d(on)}$           | turn-on delay time                    | <div> <div></div> <div>inductive load</div> <div><math>V_{CE} = 600\text{ V}; I_C = 35\text{ A}</math></div> <div><math>V_{GE} = \pm 15\text{ V}; R_G = 27\ \Omega</math></div> </div> | $T_{VJ} = 125^{\circ}\text{C}$ |         | 70   |          | ns            |
| $t_r$                 | current rise time                     |                                                                                                                                                                                        |                                |         | 40   |          | ns            |
| $t_{d(off)}$          | turn-off delay time                   |                                                                                                                                                                                        |                                |         | 250  |          | ns            |
| $t_f$                 | current fall time                     |                                                                                                                                                                                        |                                |         | 100  |          | ns            |
| $E_{on}$              | turn-on energy per pulse              |                                                                                                                                                                                        |                                |         | 3.8  |          | mJ            |
| $E_{off}$             | turn-off energy per pulse             |                                                                                                                                                                                        |                                |         | 4.1  |          | mJ            |
| <b>RBSOA</b>          | reverse bias safe operating area      | $V_{GE} = \pm 15\text{ V}; R_G = 27\ \Omega$                                                                                                                                           | $T_{VJ} = 125^{\circ}\text{C}$ |         |      |          |               |
| $I_{CM}$              |                                       | $V_{CEmax} = 1200\text{ V}$                                                                                                                                                            |                                |         |      | 105      | A             |
| <b>SCSOA</b>          | short circuit safe operating area     | $V_{CEmax} = 1200\text{ V}$                                                                                                                                                            | $T_{VJ} = 125^{\circ}\text{C}$ |         |      |          |               |
| $t_{SC}$              | short circuit duration                | $V_{CE} = 900\text{ V}; V_{GE} = \pm 15\text{ V}$                                                                                                                                      |                                |         |      | 10       | $\mu\text{s}$ |
| $I_{SC}$              | short circuit current                 | $R_G = 27\ \Omega$ ; non-repetitive                                                                                                                                                    |                                |         | 140  |          | A             |
| $R_{thJC}$            | thermal resistance junction to case   |                                                                                                                                                                                        |                                |         |      | 0.58     | K/W           |
| $R_{thCH}$            | thermal resistance case to heatsink   |                                                                                                                                                                                        |                                |         | 0.17 |          | K/W           |
| <b>Boost Diode BD</b> |                                       |                                                                                                                                                                                        |                                |         |      |          |               |
| $V_{RRM}$             | max. repetitive reverse voltage       |                                                                                                                                                                                        | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 1200     | V             |
| $I_{F25}$             | forward current                       |                                                                                                                                                                                        | $T_C = 25^{\circ}\text{C}$     |         |      | 48       | A             |
| $I_{F80}$             |                                       |                                                                                                                                                                                        | $T_C = 80^{\circ}\text{C}$     |         |      | 32       | A             |
| $V_F$                 | forward voltage                       | $I_F = 30\text{ A}$                                                                                                                                                                    | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 2.20     | V             |
|                       |                                       |                                                                                                                                                                                        | $T_{VJ} = 125^{\circ}\text{C}$ |         | 1.90 |          | V             |
| $I_R$                 | reverse current                       | $V_R = V_{RRM}$                                                                                                                                                                        | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 0.03     | mA            |
|                       |                                       |                                                                                                                                                                                        | $T_{VJ} = 125^{\circ}\text{C}$ |         | 0.15 |          | mA            |
| $Q_{rr}$              | reverse recovery charge               | <div> <div><math>V_R = 600\text{ V}</math></div> <div><math>-di_F/dt = 600\text{ A}/\mu\text{s}</math></div> <div><math>I_F = 30\text{ A}; V_{GE} = 0\text{ V}</math></div> </div>     | $T_{VJ} = 125^{\circ}\text{C}$ |         | 3.5  |          | $\mu\text{C}$ |
| $I_{RM}$              | max. reverse recovery current         |                                                                                                                                                                                        |                                |         | 30   |          | A             |
| $t_{rr}$              | reverse recovery time                 |                                                                                                                                                                                        |                                |         | 350  |          | ns            |
| $E_{rec}$             | reverse recovery energy               |                                                                                                                                                                                        |                                |         | 0.9  |          | mJ            |
| $R_{thJC}$            | thermal resistance junction to case   |                                                                                                                                                                                        |                                |         |      | 1        | K/W           |
| $R_{thCH}$            | thermal resistance case to heatsink   |                                                                                                                                                                                        |                                |         | 0.3  |          | K/W           |

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| Package SMPD         |                                                              | Ratings              |      |      |      |      |
|----------------------|--------------------------------------------------------------|----------------------|------|------|------|------|
| Symbol               | Definition                                                   | Conditions           | min. | typ. | max. | Unit |
| I <sub>RMS</sub>     | RMS current                                                  | per terminal         |      |      | 100  | A    |
| T <sub>stg</sub>     | storage temperature                                          |                      | -55  |      | 150  | °C   |
| T <sub>VJ</sub>      | virtual junction temperature                                 |                      | -55  |      | 150  | °C   |
| Weight               |                                                              |                      |      | 8.5  |      | g    |
| F <sub>C</sub>       | mounting force with clip                                     |                      | 40   |      | 130  | N    |
| V <sub>ISOL</sub>    | isolation voltage                                            | t = 1 second         | 3000 |      |      | V    |
|                      |                                                              | t = 1 minute         | 2500 |      |      | V    |
| d <sub>Spp/App</sub> | creepage distance on surface   striking distance through air | terminal to terminal | 1.6  |      |      | mm   |
| d <sub>Spb/Apb</sub> |                                                              | terminal to backside | 4.0  |      |      | mm   |



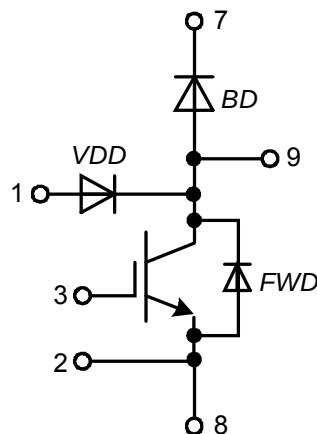
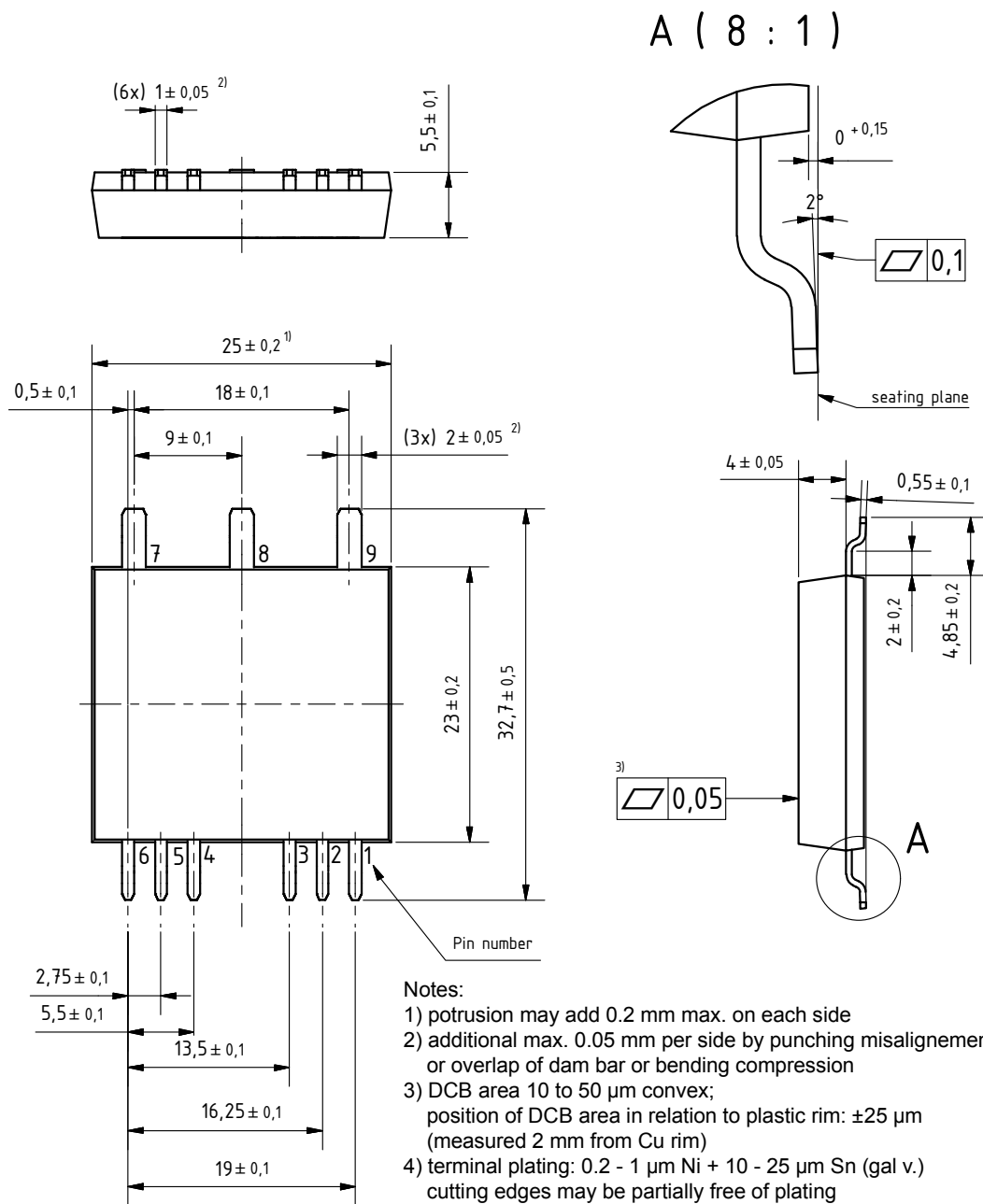
### Part number

I = IGBT  
 X = XPT IGBT  
 A = Gen 1 / std  
 40 = Current Rating [A]  
 RG = boost configuration  
 1200 = Reverse Voltage [V]  
 D = IGBT  
 H = XPT IGBT  
 G = Gen 1 / std  
 LB = SMPD-B

| Ordering    | Part Number          | Marking on Product | Delivery Mode | Quantity | Code No. |
|-------------|----------------------|--------------------|---------------|----------|----------|
| Standard    | IXA40RG1200DHGLB     | IXA40RG1200DHGLB   | Blister       | 45       | 512363   |
| Alternative | IXA40RG1200DHGLB-TRR | IXA40RG1200DHGLB   | Tape & Reel   | 200      | 511661   |

| Similar Part     | Package | Voltage class |
|------------------|---------|---------------|
| IXA20RG1200DHGLB | SMPD-B  | 1200          |
| IXA30RG1200DHGLB | SMPD-B  | 1200          |

## Outlines SMPD



## Boost IGBT

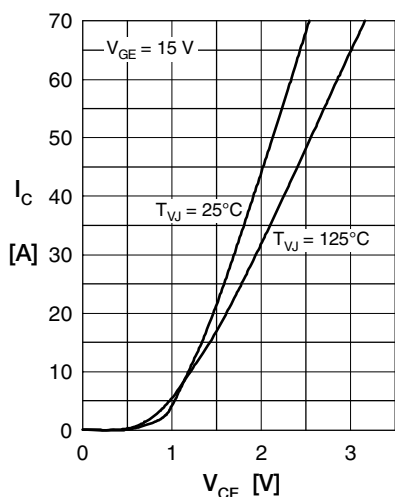


Fig. 1 Typ. output characteristics

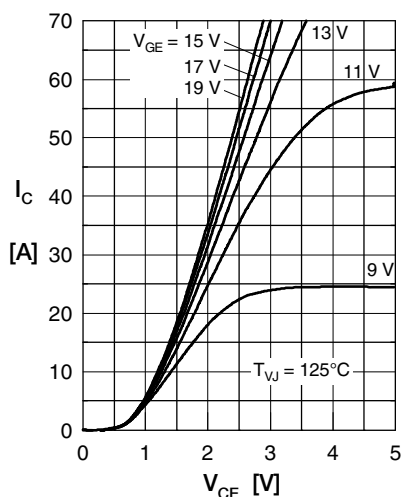


Fig. 2 Typ. output characteristics

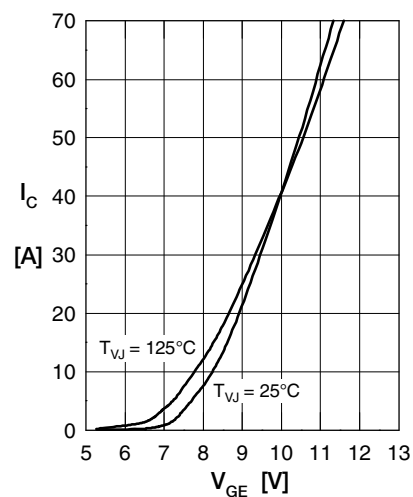


Fig. 3 Typ. transfer characteristics

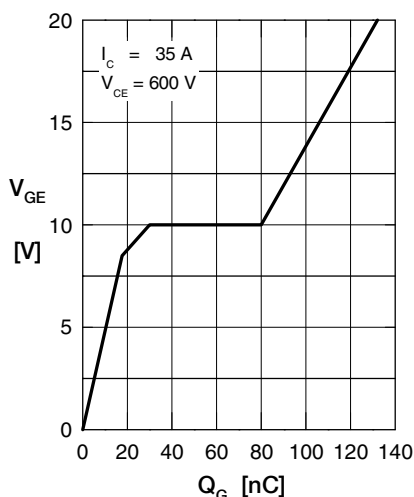


Fig. 4 Typ. turn-on gate charge

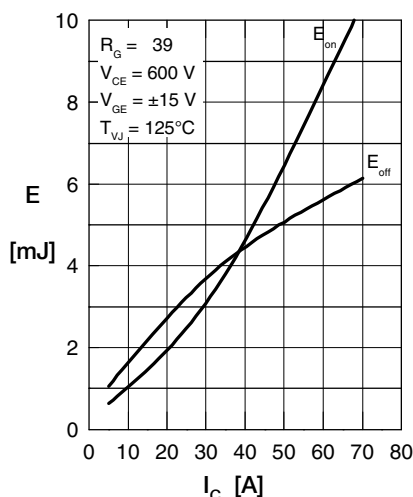


Fig. 5 Typ. switching energy versus collector current

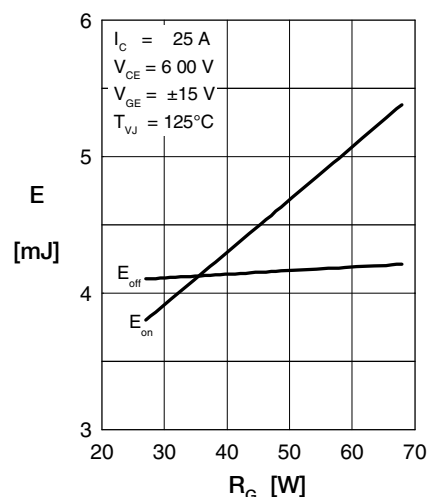


Fig. 6 Typ. switching energy versus gate resistance

Fig. 7 Typ. transient thermal impedance junction to case

## Boost Diode BD

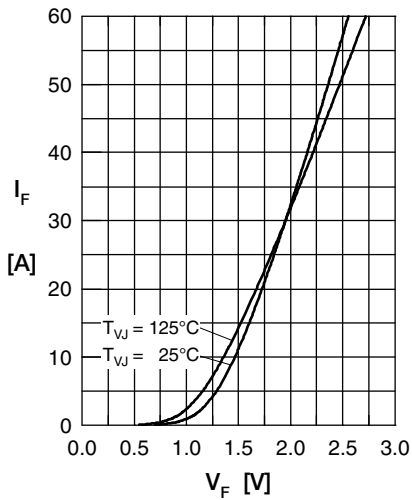


Fig. 1 Typ. Forward current versus  $V_F$

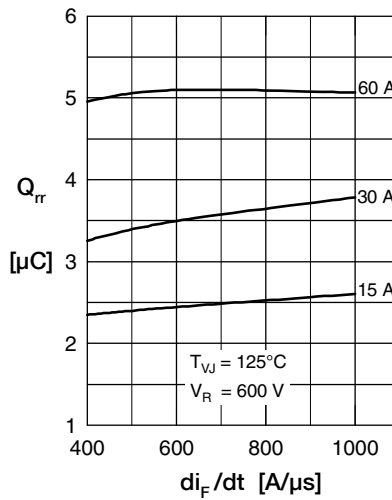


Fig. 2 Typ. reverse recov.charge  $Q_{rr}$  versus  $di/dt$

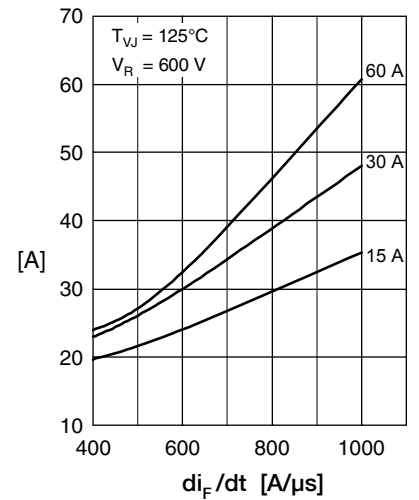


Fig. 3 Typ. peak reverse current  $I_{RM}$  versus  $di/dt$

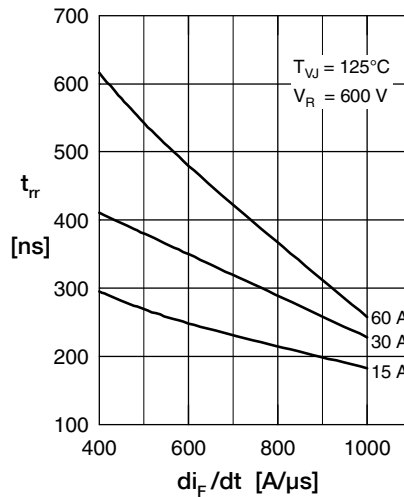


Fig. 4 Dynamic parameters  $Q_{rr}$ ,  $I_{RM}$  versus  $di/dt$

Fig. 5 Typ. recovery time  $t_{rr}$  versus  $di/dt$

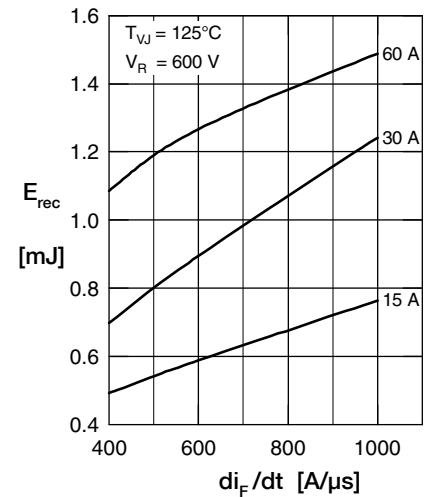


Fig. 6 Typ. recovery energy  $E_{rec}$  versus  $di/dt$

Fig. 7 Typ. transient thermal impedance junction to case



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